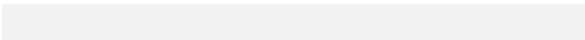





1-layer Copper-Carrier Kupfer-Träger

Top L1	solder mask		15 µm	Lacquer
	outer layer		35 µm	Copper
	prepreg		100 µm	Dielectric
	Copper Core		1500 µm	Copper
Total finished thickness:			1,65 mm	
Tolerance ±			10%	
Maximum thickness			1,82 mm	
Minimum thickness			1,49 mm	

Note:

The following options are available for copper thickness, prepreg and copper-core thickness:
Standards are marked **bold**

Hinweis:

Für Kupferdicke, Prepreg und Kupferkerndicke gibt es folgende Wahlmöglichkeiten:
Standards sind **fett** markiert

Copper thickness	35 / 70 [µm]
Dielectric thickness	75 / 100 [µm]
Dielectric W/mK	3,0 / 4,2 / 7,0 [W/mK]
Copper Core thickness	1,0 / 1,5 [mm]
Alloy:	C1100